

DATA SHEET

BFG540W **BFG540W/X; BFG540W/XR** NPN 9 GHz wideband transistor

Product specification
Supersedes data of August 1995
File under Discrete Semiconductors, SC14

1997 Dec 04

NPN 9 GHz wideband transistor

BFG540W
BFG540W/X; BFG540W/XR

FEATURES

- High power gain
- Low noise figure
- High transition frequency
- Gold metallization ensures excellent reliability.

APPLICATIONS

They are intended for applications in the RF front end, in wideband applications in the GHz range such as analog and digital cellular telephones, cordless telephones (CT2, CT3, PCN, DECT, etc.), radar detectors, pagers, satellite television tuners (SATV), MATV/CATV amplifiers and repeater amplifiers in fibre-optic systems.

DESCRIPTION

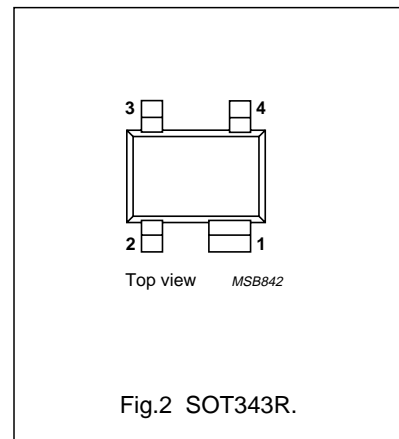
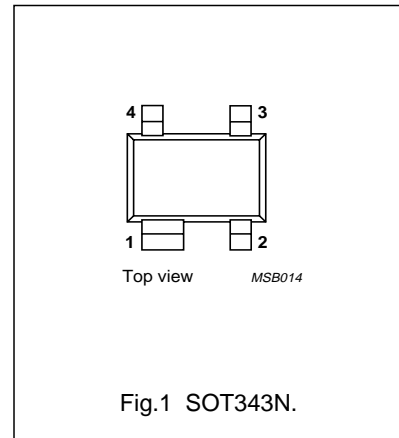
NPN silicon planar epitaxial transistors in plastic, 4-pin dual-emitter SOT343N and SOT343R packages.

MARKING

| TYPE NUMBER | CODE |
|-------------|------|
| BFG540W | N9 |
| BFG540W/X | N7 |
| BFG540W/XR | N8 |

PINNING

| PIN | DESCRIPTION |
|-------------------------------|-------------|
| BFG540W (see Fig.1) | |
| 1 | collector |
| 2 | base |
| 3 | emitter |
| 4 | emitter |
| BFG540W/X (see Fig.1) | |
| 1 | collector |
| 2 | emitter |
| 3 | base |
| 4 | emitter |
| BFG540W/XR (see Fig.2) | |
| 1 | collector |
| 2 | emitter |
| 3 | base |
| 4 | emitter |



QUICK REFERENCE DATA

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|--------------|-------------------------------|--|------|------|------|------|
| V_{CBO} | collector-base voltage | open emitter | – | – | 20 | V |
| V_{CES} | collector-emitter voltage | $R_{BE} = 0$ | – | – | 15 | V |
| I_C | collector current (DC) | | – | – | 120 | mA |
| P_{tot} | total power dissipation | up to $T_s = 85\text{ °C}$ | – | – | 500 | mW |
| h_{FE} | DC current gain | $I_C = 40\text{ mA}$; $V_{CE} = 8\text{ V}$ | 60 | 120 | 250 | |
| C_{re} | feedback capacitance | $I_C = 0$; $V_{CB} = 8\text{ V}$; $f = 1\text{ MHz}$ | – | 0.5 | – | pF |
| f_T | transition frequency | $I_C = 40\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 1\text{ GHz}$; $T_{amb} = 25\text{ °C}$ | – | 9 | – | GHz |
| G_{UM} | maximum unilateral power gain | $I_C = 40\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 900\text{ MHz}$; $T_{amb} = 25\text{ °C}$ | – | 16 | – | dB |
| | | $I_C = 40\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 2\text{ GHz}$; $T_{amb} = 25\text{ °C}$ | – | 10 | – | dB |
| $ S_{21} ^2$ | insertion power gain | $I_C = 40\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 900\text{ MHz}$; $T_{amb} = 25\text{ °C}$ | 14 | 15 | – | dB |
| F | noise figure | $\Gamma_s = \Gamma_{opt}$; $I_C = 10\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 2\text{ GHz}$ | – | 2.1 | – | dB |

NPN 9 GHz wideband transistor

BFG540W
BFG540W/X; BFG540W/XR**LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 134).

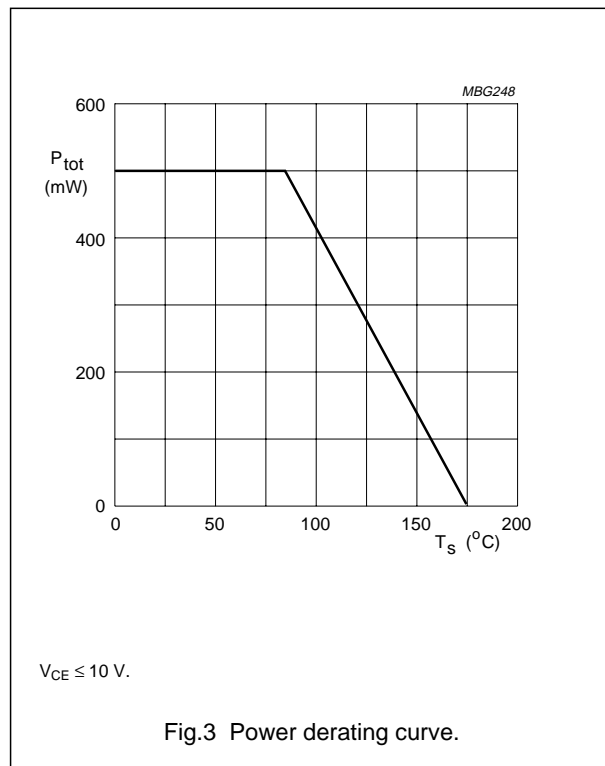
| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|-----------|---------------------------|--|------|------|------|
| V_{CBO} | collector-base voltage | open emitter | – | 20 | V |
| V_{CES} | collector-emitter voltage | $R_{BE} = 0$ | – | 15 | V |
| V_{EBO} | emitter-base voltage | open collector | – | 2.5 | V |
| I_C | collector current (DC) | | – | 120 | mA |
| P_{tot} | total power dissipation | up to $T_s = 85\text{ °C}$; see Fig.3; note 1 | – | 500 | mW |
| T_{stg} | storage temperature | | –65 | +150 | °C |
| T_j | junction temperature | | – | 175 | °C |

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|---------------|---|-------------------------------------|-------|------|
| $R_{th\ j-s}$ | thermal resistance from junction to soldering point | up to $T_s = 85\text{ °C}$; note 1 | 180 | K/W |

Note to the “Limiting values” and “Thermal characteristics”

- T_s is the temperature at the soldering point of the collector pin.



NPN 9 GHz wideband transistor

BFG540W
BFG540W/X; BFG540W/XR

CHARACTERISTICS

T_j = 25 °C (unless otherwise specified).

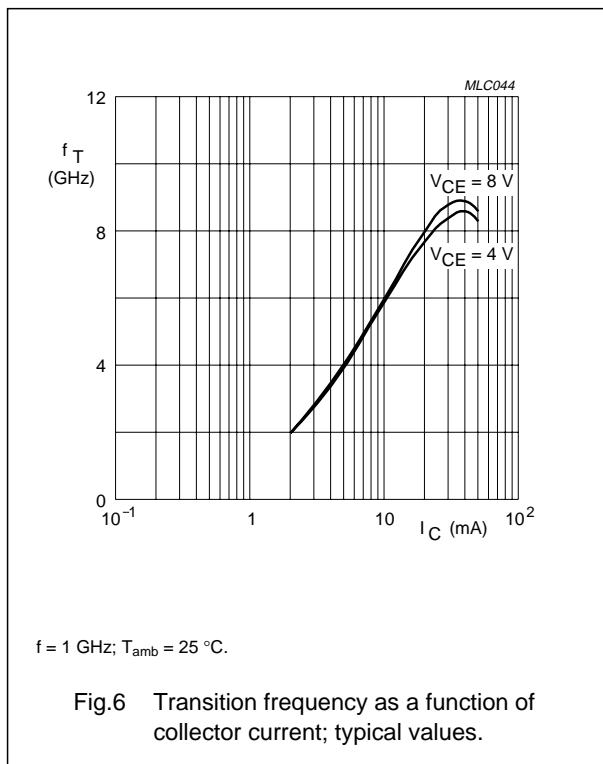
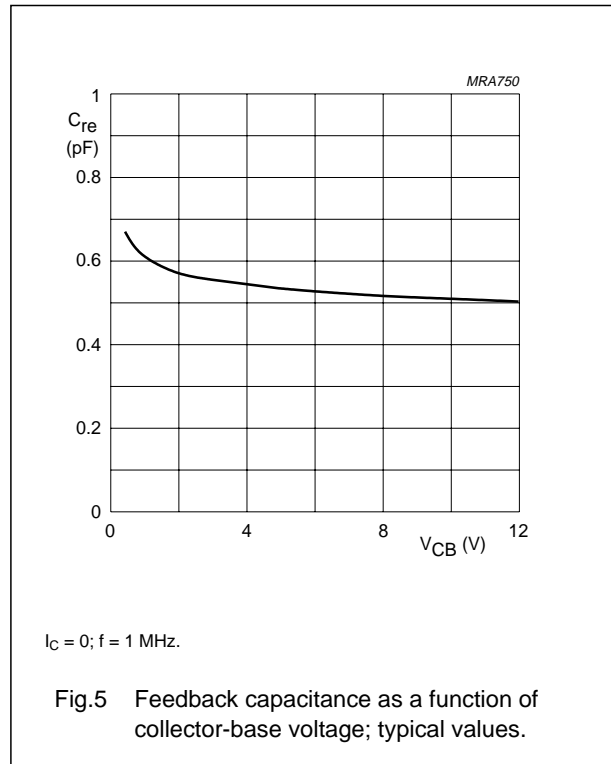
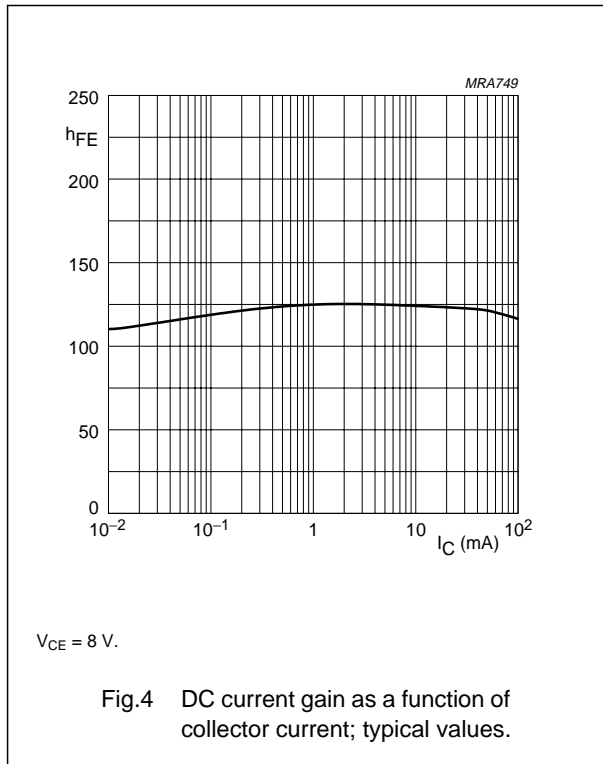
| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|--------------------------------|---|--|------|------|------|------|
| V _{(BR)CBO} | collector-base breakdown voltage | open emitter; I _C = 10 μA; I _E = 0 | 20 | – | – | V |
| V _{(BR)CES} | collector-emitter breakdown voltage | R _{BE} = 0; I _C = 40 μA | 15 | – | – | V |
| V _{(BR)EBO} | emitter-base breakdown voltage | open collector; I _E = 100 μA; I _C = 0 | 2.5 | – | – | V |
| I _{CBO} | collector cut-off current | open emitter; V _{CB} = 8 V; I _E = 0 | – | – | 50 | nA |
| h _{FE} | DC current gain | I _C = 40 mA; V _{CE} = 8 V | 60 | 120 | 250 | |
| f _T | transition frequency | I _C = 40 mA; V _{CE} = 8 V; f = 1 GHz; T _{amb} = 25 °C | – | 9 | – | GHz |
| C _c | collector capacitance | I _E = i _e = 0; V _{CB} = 8 V; f = 1 MHz | – | 0.9 | – | pF |
| C _e | emitter capacitance | I _C = i _c = 0; V _{EB} = 0.5 V; f = 1 MHz | – | 2 | – | pF |
| C _{re} | feedback capacitance | I _C = 0; V _{CB} = 8 V; f = 1 MHz | – | 0.5 | – | pF |
| G _{UM} | maximum unilateral power gain; note 1 | I _C = 40 mA; V _{CE} = 8 V; f = 900 MHz; T _{amb} = 25 °C | – | 16 | – | dB |
| | | I _C = 40 mA; V _{CE} = 8 V; f = 2 GHz; T _{amb} = 25 °C | – | 10 | – | dB |
| s ₂₁ ² | insertion power gain | I _C = 40 mA; V _{CE} = 8 V; f = 900 MHz; T _{amb} = 25 °C | 14 | 15 | – | dB |
| F | noise figure | Γ _s = Γ _{opt} ; I _C = 10 mA; V _{CE} = 8 V; f = 900 MHz | – | 1.3 | 1.8 | dB |
| | | Γ _s = Γ _{opt} ; I _C = 40 mA; V _{CE} = 8 V; f = 900 MHz | – | 1.9 | 2.4 | dB |
| | | Γ _s = Γ _{opt} ; I _C = 10 mA; V _{CE} = 8 V; f = 2 GHz | – | 2.1 | – | dB |
| PL1 | output power at 1 dB gain compression | I _C = 40 mA; V _{CE} = 8 V; f = 900 MHz; R _L = 50 Ω; T _{amb} = 25 °C | – | 21 | – | dBm |
| ITO | third order intercept point | note 2 | – | 34 | – | dBm |
| V _o | output voltage | note 3 | – | 500 | – | mV |
| d ₂ | second order intermodulation distortion | note 4 | – | –50 | – | dB |

Notes

- G_{UM} is the maximum unilateral power gain, assuming s₁₂ is zero. $G_{UM} = 10 \log \frac{|s_{21}|^2}{(1 - |s_{11}|^2)(1 - |s_{22}|^2)}$ dB.
- I_C = 40 mA; V_{CE} = 8 V; R_L = 50 Ω; T_{amb} = 25 °C;
 - f_p = 900 MHz; f_q = 902 MHz; measured at f_(2p-q) = 898 MHz and f_(2q-p) = 904 MHz.
- d_{im} = –60 dB (DIN45004B); V_p = V_o; V_q = V_o – 6 dB; V_r = V_o – 6 dB; R_L = 75 Ω; V_{CE} = 8 V; I_C = 40 mA;
 - f_p = 795.25 MHz; f_q = 803.25 MHz; f_r = 805.25 MHz; measured at f_(p+q-r) = 793.25 MHz.
- I_C = 40 mA; V_{CE} = 8 V; V_o = 275 mV; R_L = 75 Ω; T_{amb} = 25 °C;
 - f_p = 250 MHz; f_q = 560 MHz; measured at f_(p+q) = 810 MHz.

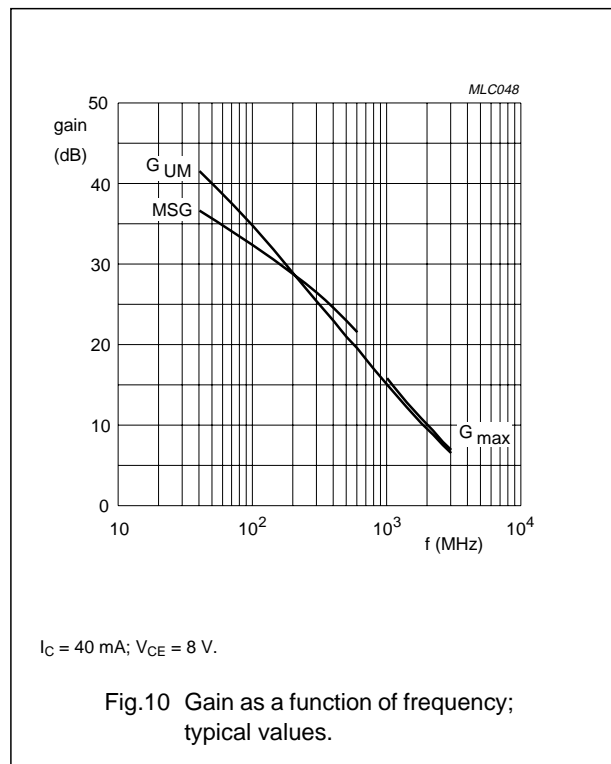
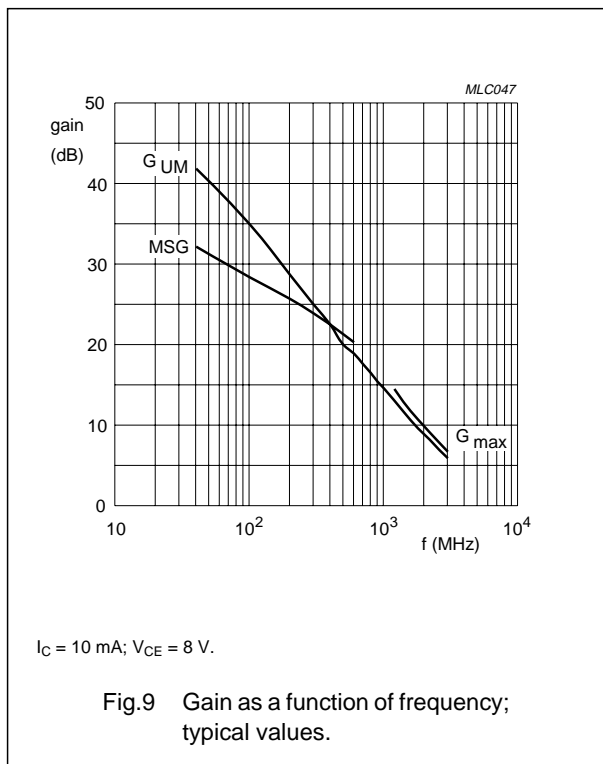
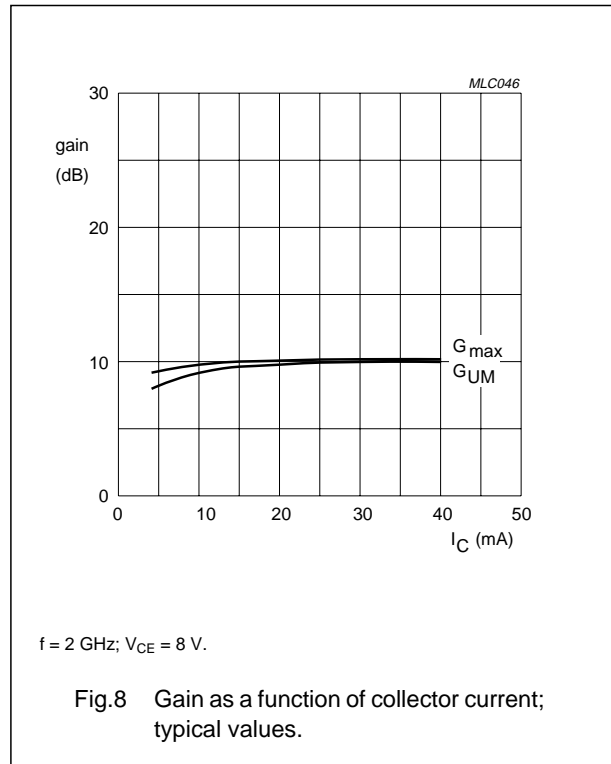
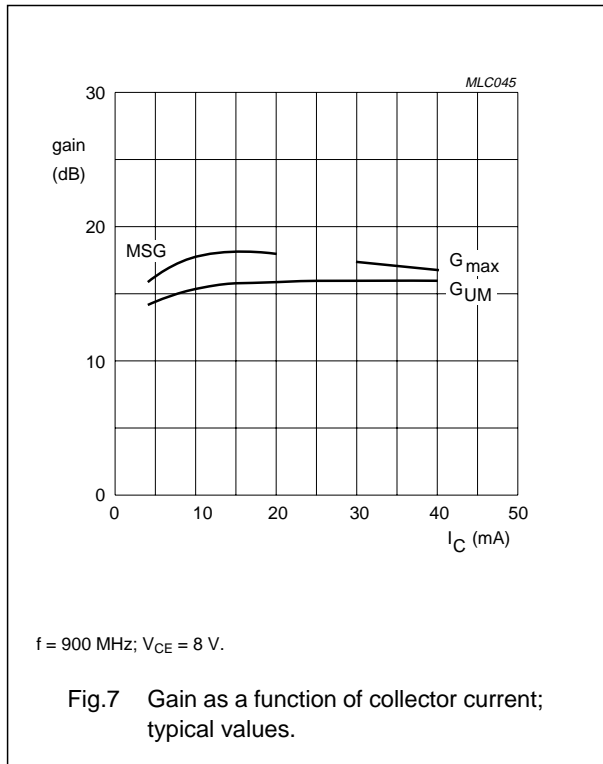
NPN 9 GHz wideband transistor

BFG540W
BFG540W/X; BFG540W/XR



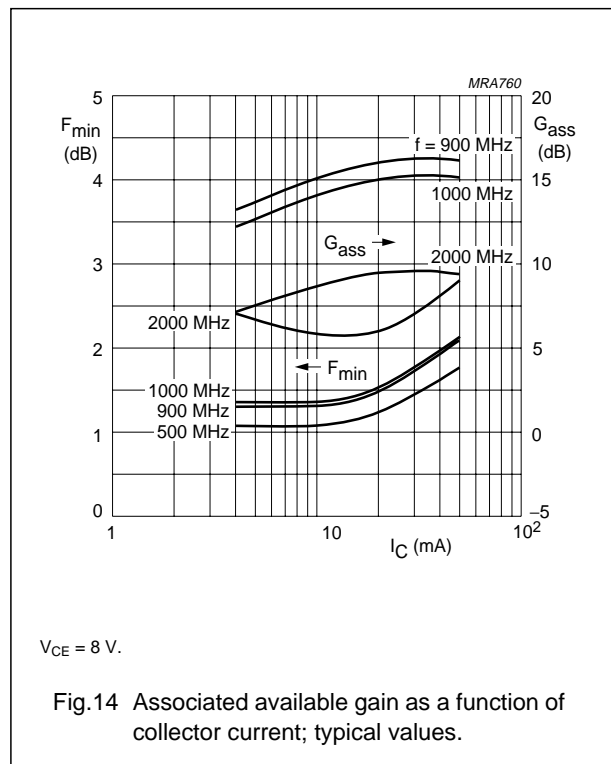
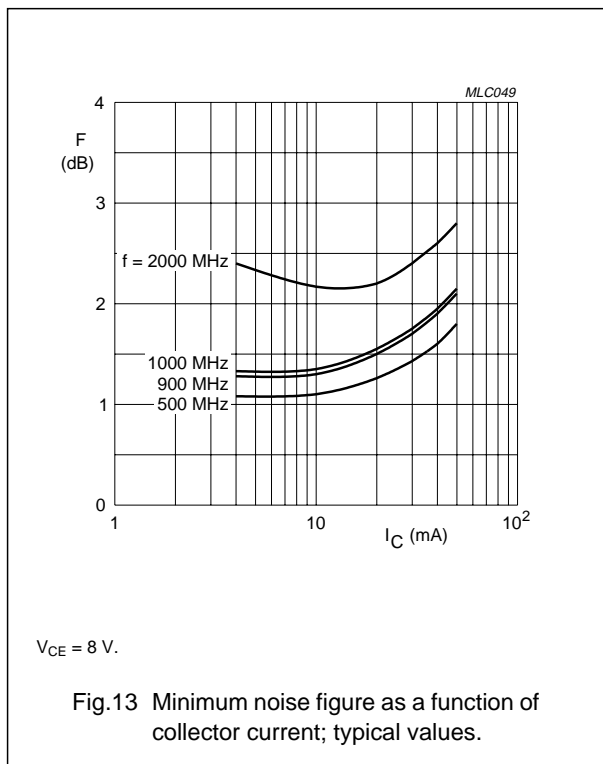
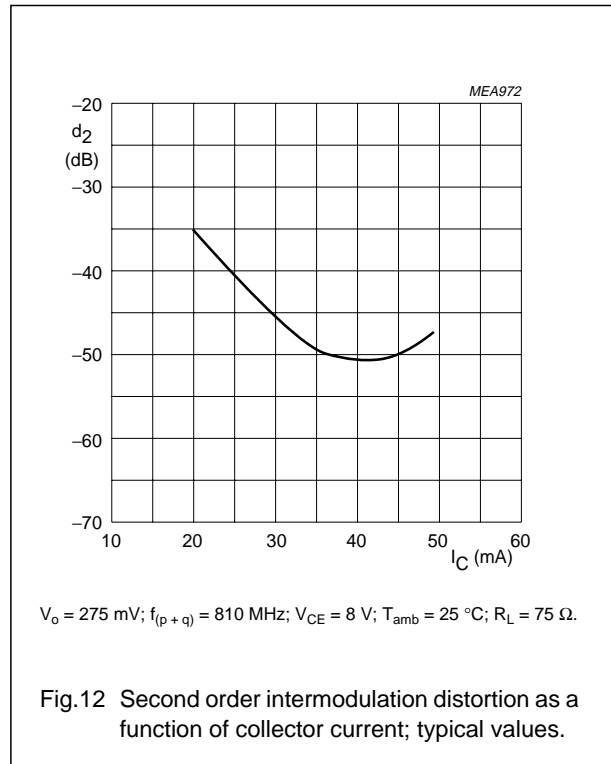
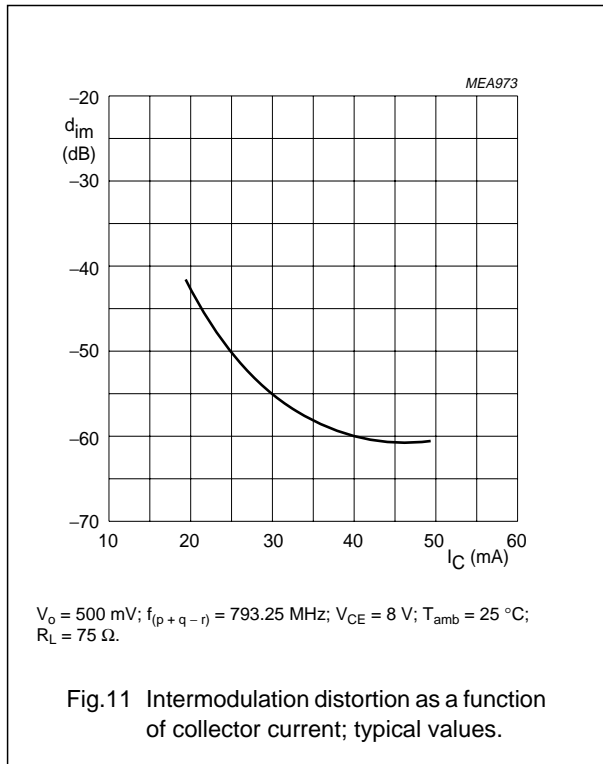
NPN 9 GHz wideband transistor

BFG540W
BFG540W/X; BFG540W/XR



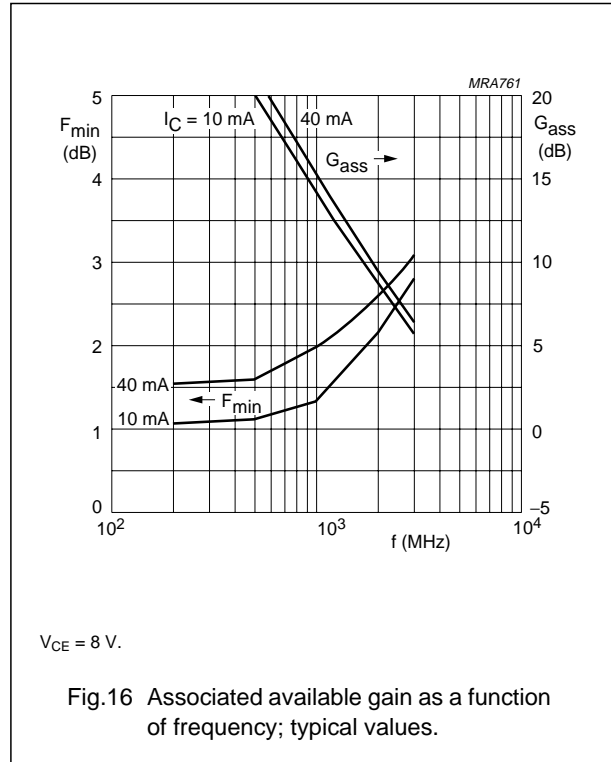
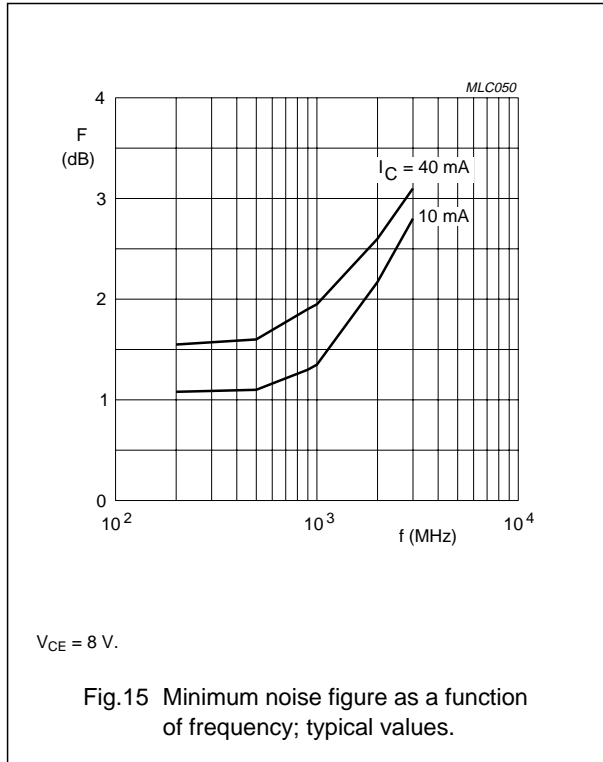
NPN 9 GHz wideband transistor

BFG540W
BFG540W/X; BFG540W/XR



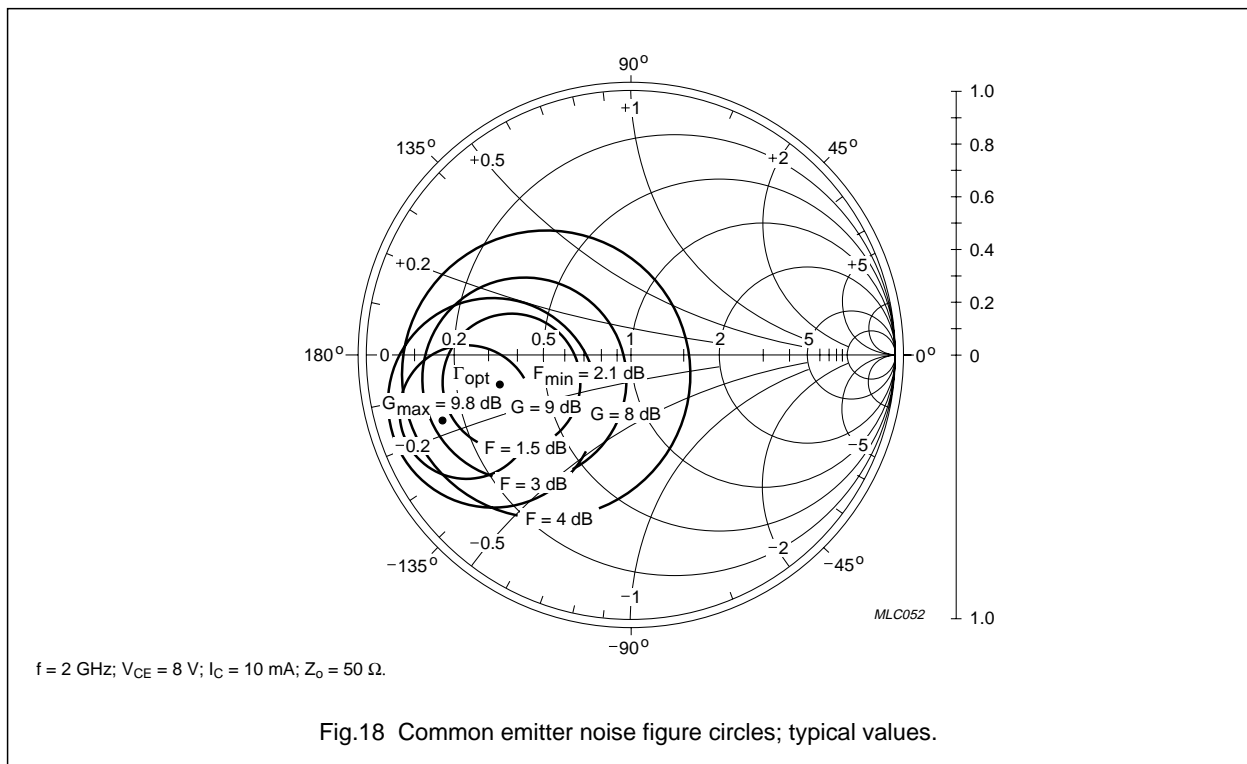
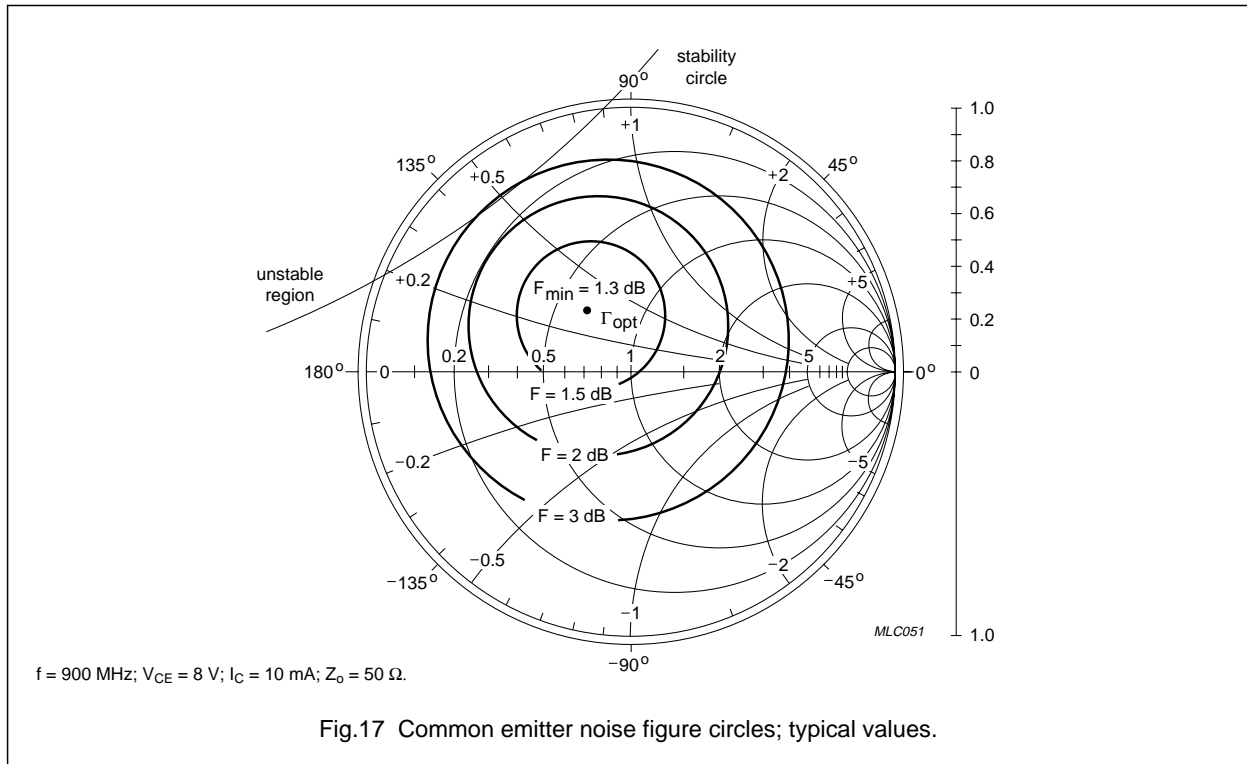
NPN 9 GHz wideband transistor

BFG540W
BFG540W/X; BFG540W/XR



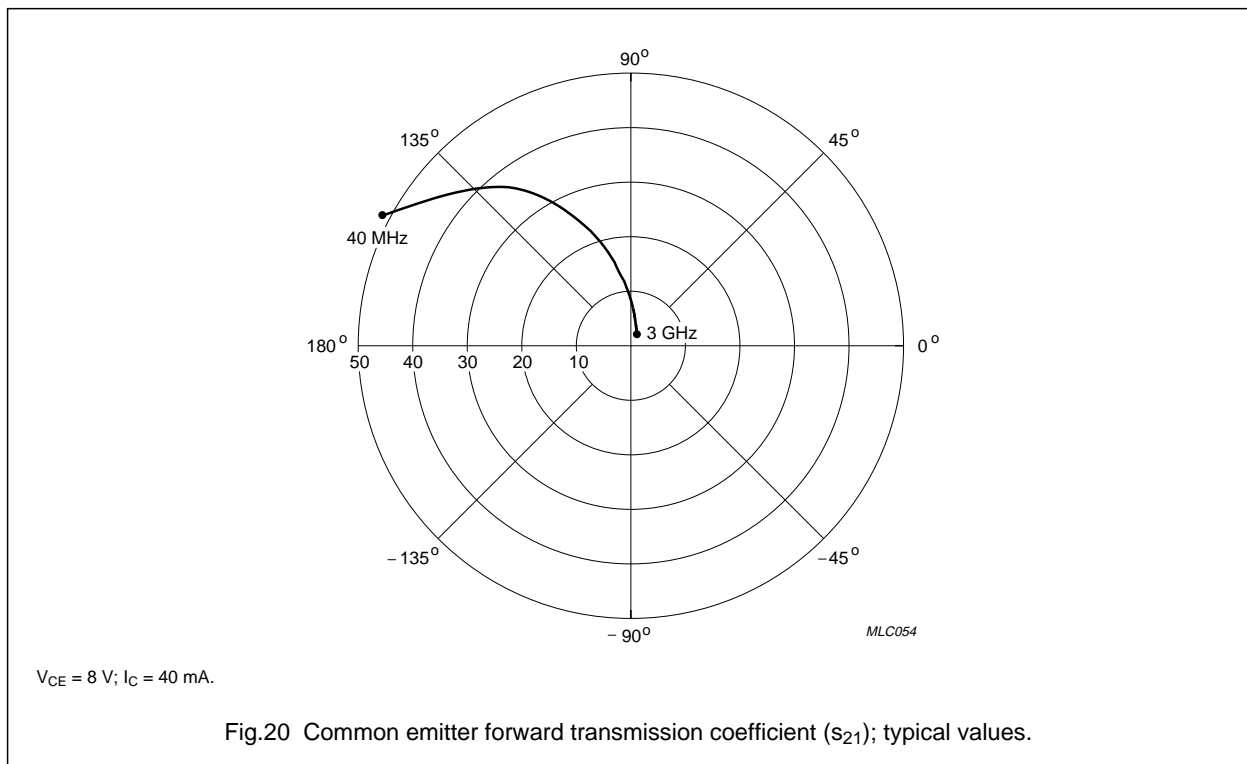
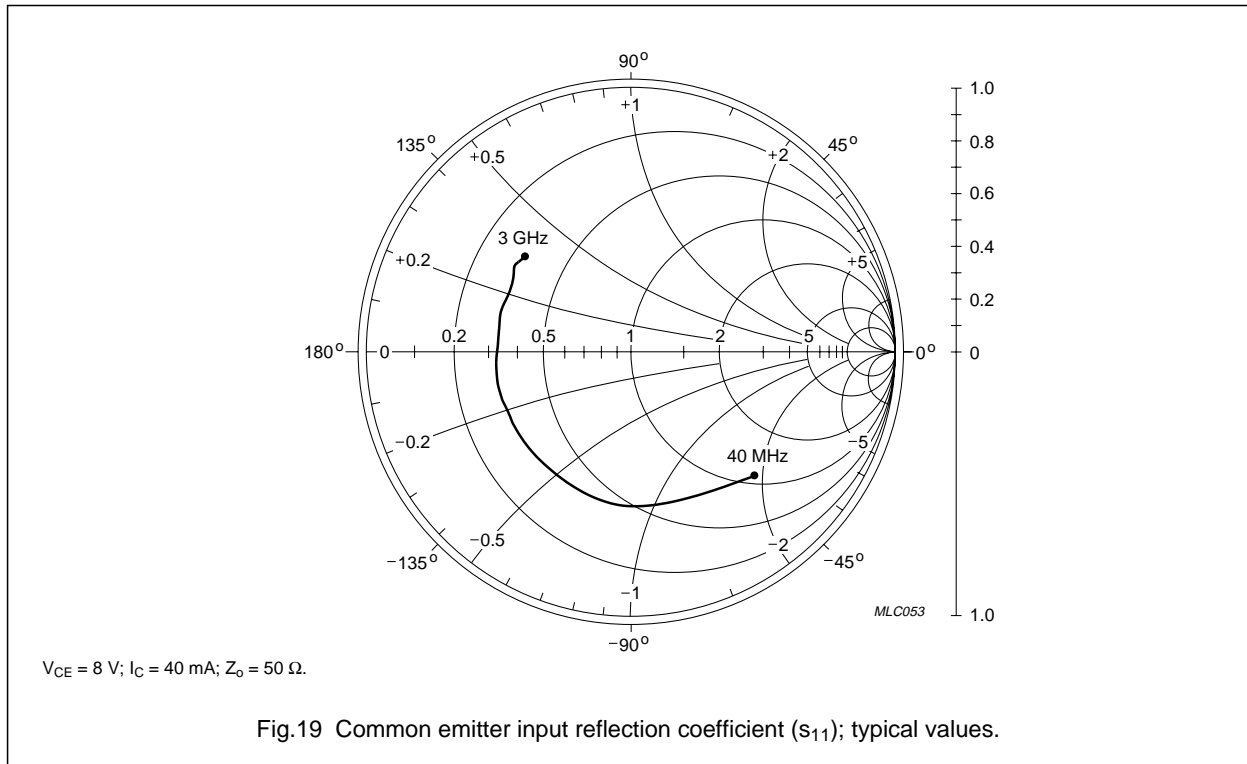
NPN 9 GHz wideband transistor

BFG540W
BFG540W/X; BFG540W/XR



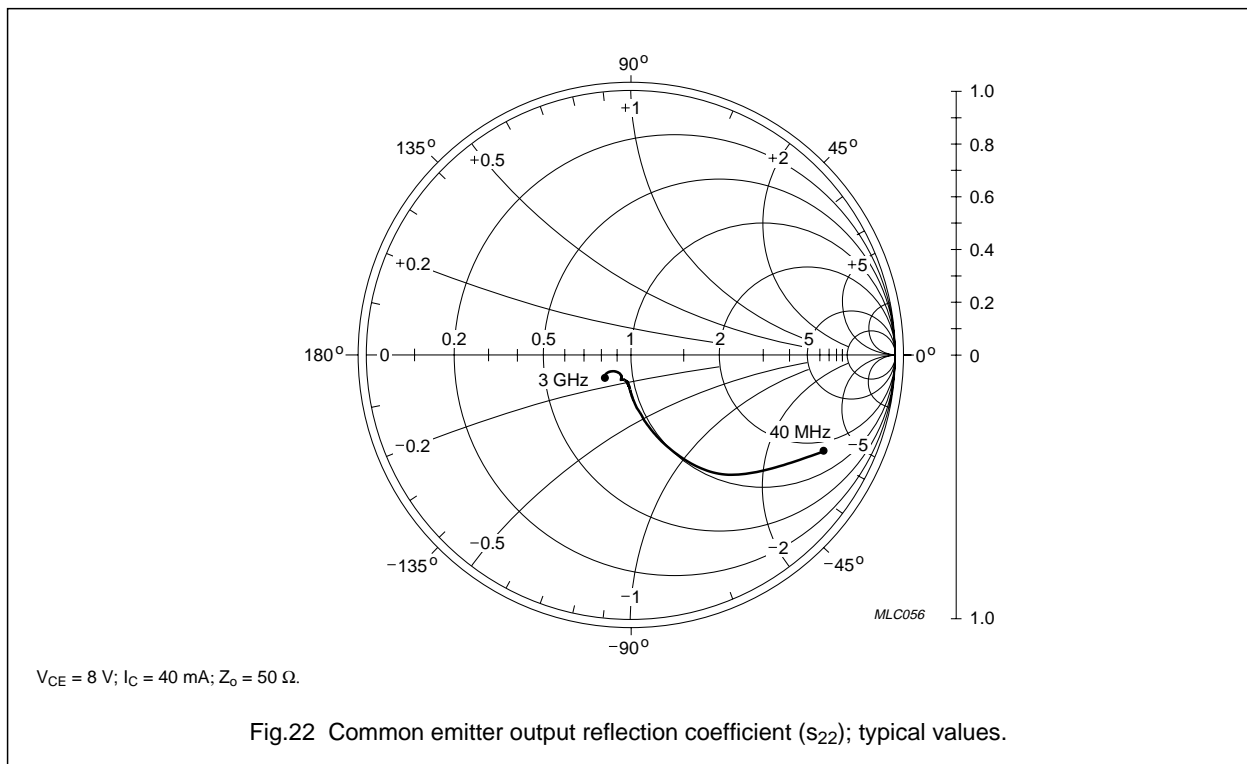
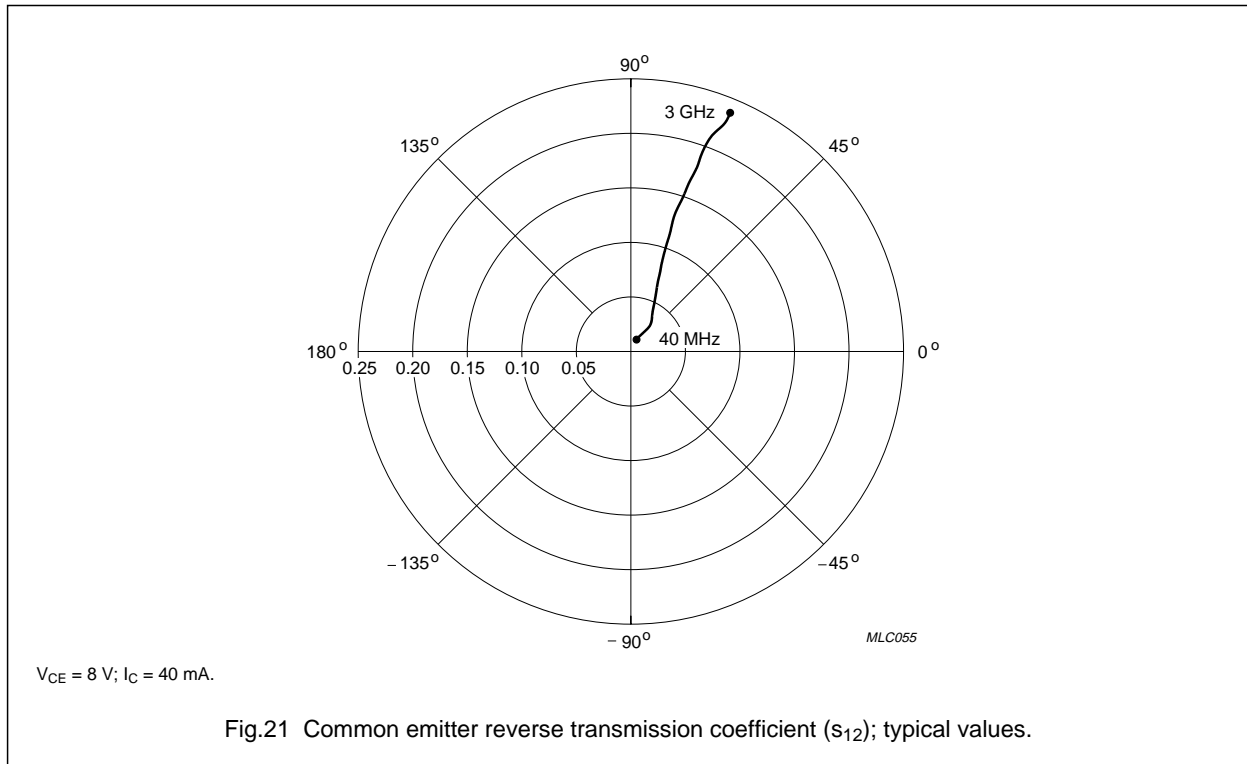
NPN 9 GHz wideband transistor

BFG540W
BFG540W/X; BFG540W/XR



NPN 9 GHz wideband transistor

BFG540W
BFG540W/X; BFG540W/XR



NPN 9 GHz wideband transistor

BFG540W
BFG540W/X; BFG540W/XR

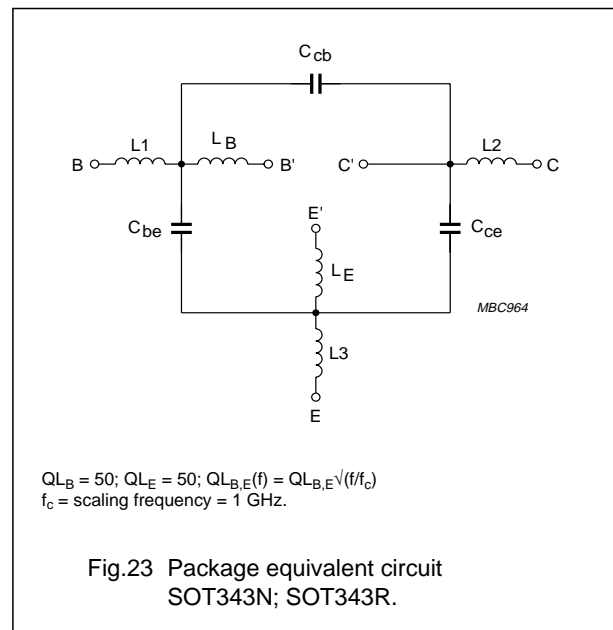
SPICE parameters for the BFG540W crystal

| SEQUENCE No. | PARAMETER | VALUE | UNIT |
|--------------|-----------|-------|------------|
| 1 | IS | 1.045 | fA |
| 2 | BF | 184.3 | – |
| 3 | NF | 0.981 | – |
| 4 | VAF | 41.69 | V |
| 5 | IKF | 10.00 | A |
| 6 | ISE | 232.4 | fA |
| 7 | NE | 2.028 | – |
| 8 | BR | 43.99 | – |
| 9 | NR | 0.992 | – |
| 10 | VAR | 2.097 | V |
| 11 | IKR | 166.2 | mA |
| 12 | ISC | 129.8 | aA |
| 13 | NC | 1.064 | – |
| 14 | RB | 5.000 | Ω |
| 15 | IRB | 1.000 | μ A |
| 16 | RBM | 5.000 | Ω |
| 17 | RE | 353.5 | m Ω |
| 18 | RC | 1.340 | Ω |
| 19 (1) | XTB | 0.000 | – |
| 20 (1) | EG | 1.110 | eV |
| 21 (1) | XTI | 3.000 | – |
| 22 | CJE | 1.978 | pF |
| 23 | VJE | 600.0 | mV |
| 24 | MJE | 0.332 | – |
| 25 | TF | 7.457 | ps |
| 26 | XTF | 11.40 | – |
| 27 | VTF | 3.158 | V |
| 28 | ITF | 156.9 | mA |
| 29 | PTF | 0.000 | deg |
| 30 | CJC | 793.7 | fF |
| 31 | VJC | 185.5 | mV |
| 32 | MJC | 0.084 | – |
| 33 | XCJC | 0.150 | – |
| 34 | TR | 1.598 | ns |
| 35 (1) | CJS | 0.000 | F |

| SEQUENCE No. | PARAMETER | VALUE | UNIT |
|--------------|-----------|-------|------|
| 36 (1) | VJS | 750.0 | mV |
| 37 (1) | MJS | 0.000 | – |
| 38 | FC | 0.814 | – |

Note

1. These parameters have not been extracted, the default values are shown.

**List of components** (see Fig.23).

| DESIGNATION | VALUE | UNIT |
|-------------|-------|------|
| C_{be} | 70 | fF |
| C_{cb} | 50 | fF |
| C_{ce} | 115 | fF |
| L1 | 0.34 | nH |
| L2 | 0.10 | nH |
| L3 | 0.25 | nH |
| L_B | 0.40 | nH |
| L_E | 0.40 | nH |

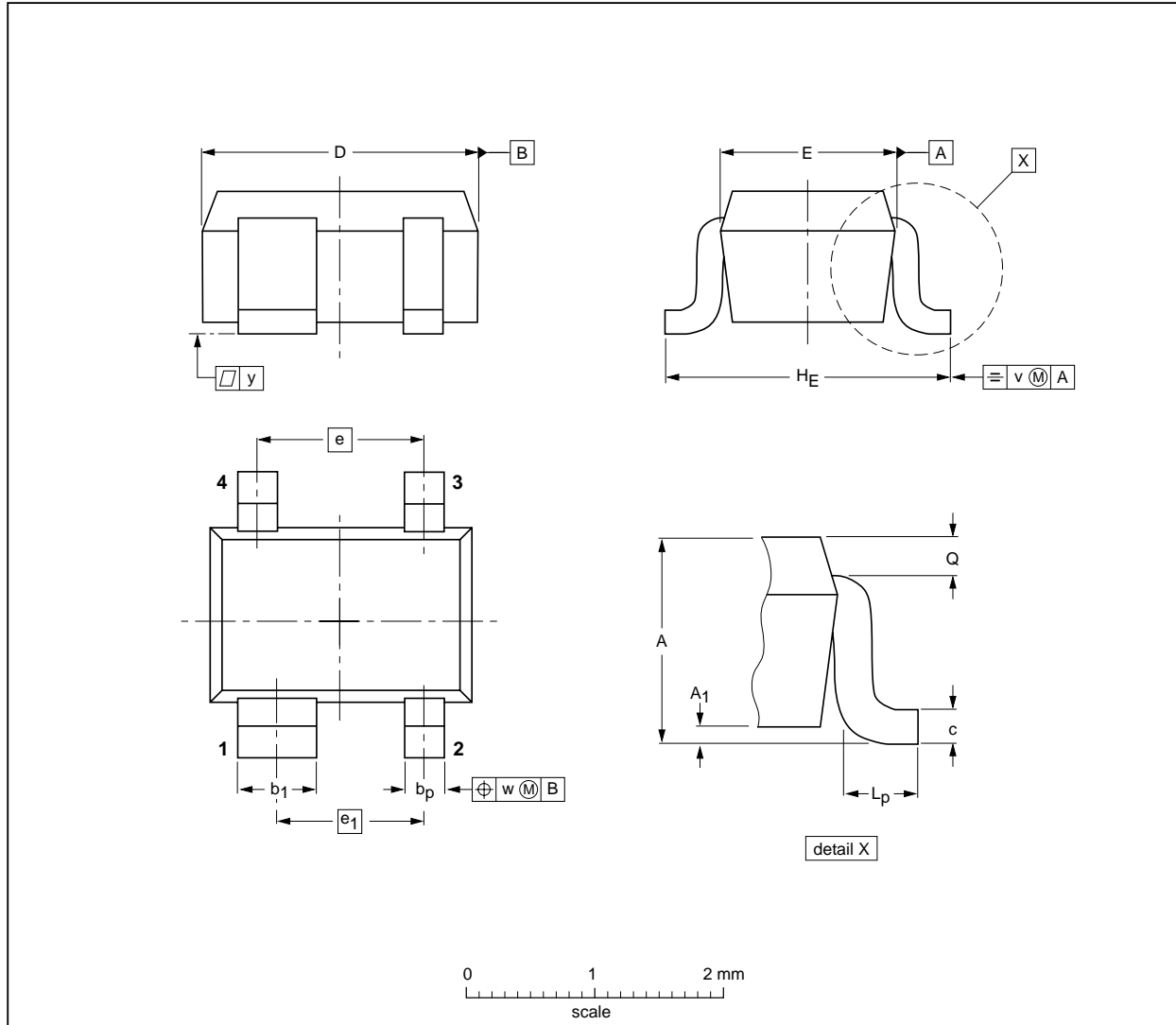
NPN 9 GHz wideband transistor

BFG540W
BFG540W/X; BFG540W/XR

PACKAGE OUTLINES

Plastic surface mounted package; 4 leads

SOT343N



DIMENSIONS (mm are the original dimensions)

| UNIT | A | A ₁ max | b _p | b ₁ | c | D | E | e | e ₁ | H _E | L _p | Q | v | w | y |
|------|------------|--------------------|----------------|----------------|--------------|------------|--------------|-----|----------------|----------------|----------------|--------------|-----|-----|-----|
| mm | 1.1 0.8 | 0.1 | 0.4 0.3 | 0.7 0.5 | 0.25 0.10 | 2.2 1.8 | 1.35 1.15 | 1.3 | 1.15 | 2.2 2.0 | 0.45 0.15 | 0.23 0.13 | 0.2 | 0.2 | 0.1 |

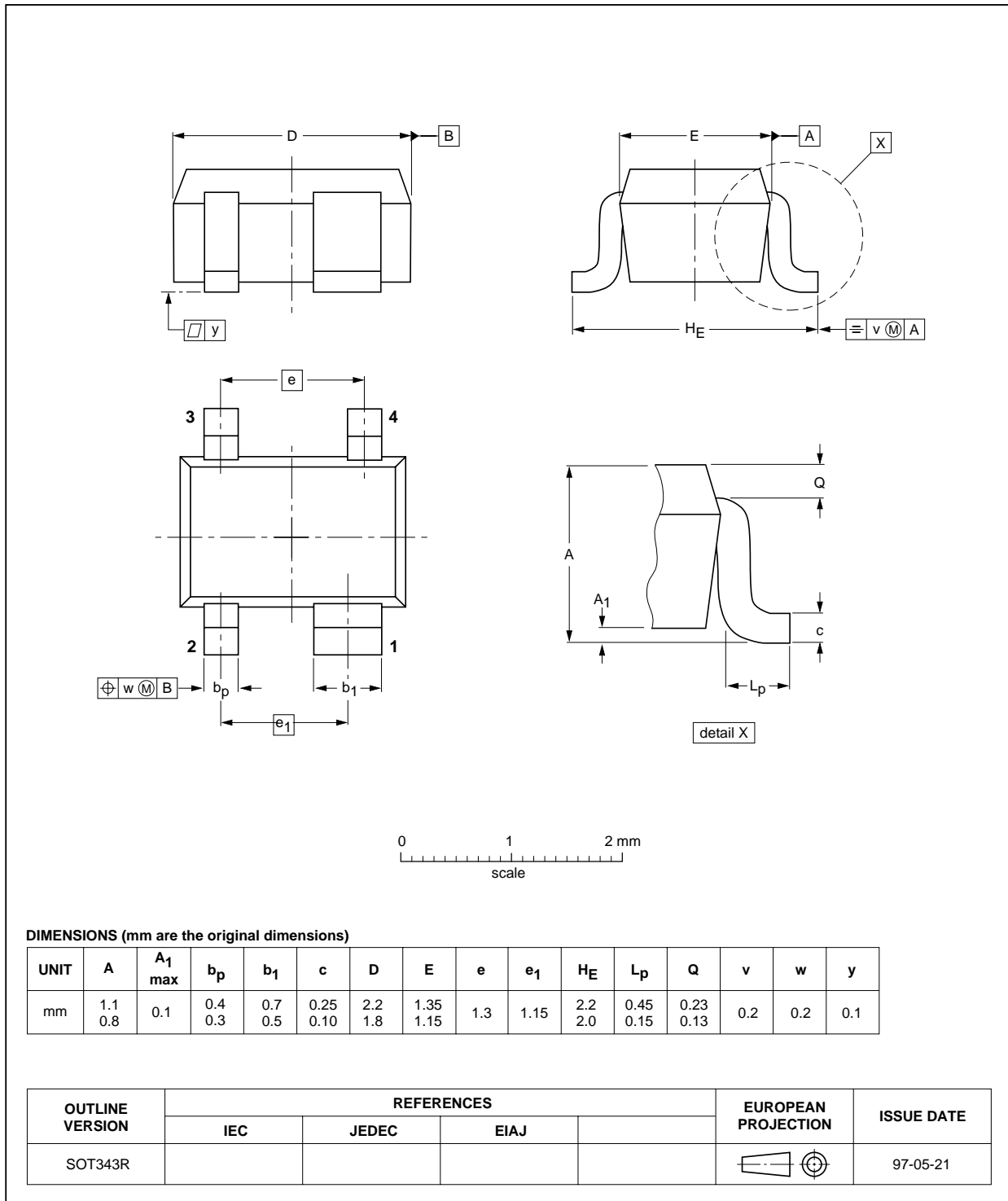
| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|-------|------|--|---------------------|------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT343N | | | | | | 97-05-21 |

NPN 9 GHz wideband transistor

BFG540W
BFG540W/X; BFG540W/XR

Plastic surface mounted package; reverse pinning; 4 leads

SOT343R



NPN 9 GHz wideband transistor

BFG540W
BFG540W/X; BFG540W/XR**DEFINITIONS**

| Data Sheet Status | |
|---|---|
| Objective specification | This data sheet contains target or goal specifications for product development. |
| Preliminary specification | This data sheet contains preliminary data; supplementary data may be published later. |
| Product specification | This data sheet contains final product specifications. |
| Limiting values | |
| Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability. | |
| Application information | |
| Where application information is given, it is advisory and does not form part of the specification. | |

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

Philips Semiconductors – a worldwide company

Argentina: see South America

Australia: 34 Waterloo Road, NORTH RYDE, NSW 2113,
Tel. +61 2 9805 4455, Fax. +61 2 9805 4466

Austria: Computerstr. 6, A-1101 WIEN, P.O. Box 213, Tel. +43 160 1010,
Fax. +43 160 101 1210

Belarus: Hotel Minsk Business Center, Bld. 3, r. 1211, Volodarski Str. 6,
220050 MINSK, Tel. +375 172 200 733, Fax. +375 172 200 773

Belgium: see The Netherlands

Brazil: see South America

Bulgaria: Philips Bulgaria Ltd., Energoproject, 15th floor,
51 James Bourchier Blvd., 1407 SOFIA,
Tel. +359 2 689 211, Fax. +359 2 689 102

Canada: PHILIPS SEMICONDUCTORS/COMPONENTS,
Tel. +1 800 234 7381

China/Hong Kong: 501 Hong Kong Industrial Technology Centre,
72 Tat Chee Avenue, Kowloon Tong, HONG KONG,
Tel. +852 2319 7888, Fax. +852 2319 7700

Colombia: see South America

Czech Republic: see Austria

Denmark: Prags Boulevard 80, PB 1919, DK-2300 COPENHAGEN S,
Tel. +45 32 88 2636, Fax. +45 31 57 0044

Finland: Sinikalliontie 3, FIN-02630 ESPOO,
Tel. +358 9 615800, Fax. +358 9 61580920

France: 51 Rue Carnot, BP317, 92156 SURESNES Cedex,
Tel. +33 1 40 99 6161, Fax. +33 1 40 99 6427

Germany: Hammerbrookstraße 69, D-20097 HAMBURG,
Tel. +49 40 23 53 60, Fax. +49 40 23 536 300

Greece: No. 15, 25th March Street, GR 17778 TAVROS/ATHENS,
Tel. +30 1 4894 339/239, Fax. +30 1 4814 240

Hungary: see Austria

India: Philips INDIA Ltd, Band Box Building, 2nd floor,
254-D, Dr. Annie Besant Road, Worli, MUMBAI 400 025,
Tel. +91 22 493 8541, Fax. +91 22 493 0966

Indonesia: see Singapore

Ireland: Newstead, Clonskeagh, DUBLIN 14,
Tel. +353 1 7640 000, Fax. +353 1 7640 200

Israel: RAPAC Electronics, 7 Kehilat Saloniki St, PO Box 18053,
TEL AVIV 61180, Tel. +972 3 645 0444, Fax. +972 3 649 1007

Italy: PHILIPS SEMICONDUCTORS, Piazza IV Novembre 3,
20124 MILANO, Tel. +39 2 6752 2531, Fax. +39 2 6752 2557

Japan: Philips Bldg 13-37, Kohnan 2-chome, Minato-ku, TOKYO 108,
Tel. +81 3 3740 5130, Fax. +81 3 3740 5077

Korea: Philips House, 260-199 Itaewon-dong, Yongsan-ku, SEOUL,
Tel. +82 2 709 1412, Fax. +82 2 709 1415

Malaysia: No. 76 Jalan Universiti, 46200 PETALING JAYA, SELANGOR,
Tel. +60 3 750 5214, Fax. +60 3 757 4880

Mexico: 5900 Gateway East, Suite 200, EL PASO, TEXAS 79905,
Tel. +9-5 800 234 7381

Middle East: see Italy

Netherlands: Postbus 90050, 5600 PB EINDHOVEN, Bldg. VB,
Tel. +31 40 27 82785, Fax. +31 40 27 88399

New Zealand: 2 Wagener Place, C.P.O. Box 1041, AUCKLAND,
Tel. +64 9 849 4160, Fax. +64 9 849 7811

Norway: Box 1, Manglerud 0612, OSLO,
Tel. +47 22 74 8000, Fax. +47 22 74 8341

Philippines: Philips Semiconductors Philippines Inc.,
106 Valero St. Salcedo Village, P.O. Box 2108 MCC, MAKATI,
Metro MANILA, Tel. +63 2 816 6380, Fax. +63 2 817 3474

Poland: Ul. Lukiska 10, PL 04-123 WARSZAWA,
Tel. +48 22 612 2831, Fax. +48 22 612 2327

Portugal: see Spain

Romania: see Italy

Russia: Philips Russia, Ul. Usatcheva 35A, 119048 MOSCOW,
Tel. +7 095 755 6918, Fax. +7 095 755 6919

Singapore: Lorong 1, Toa Payoh, SINGAPORE 1231,
Tel. +65 350 2538, Fax. +65 251 6500

Slovakia: see Austria

Slovenia: see Italy

South Africa: S.A. PHILIPS Pty Ltd., 195-215 Main Road Martindale,
2092 JOHANNESBURG, P.O. Box 7430 Johannesburg 2000,
Tel. +27 11 470 5911, Fax. +27 11 470 5494

South America: Al. Vicente Pinzon, 173, 6th floor,
04547-130 SÃO PAULO, SP, Brazil,
Tel. +55 11 821 2333, Fax. +55 11 821 2382

Spain: Balmes 22, 08007 BARCELONA,
Tel. +34 3 301 6312, Fax. +34 3 301 4107

Sweden: Kottbygatan 7, Akalla, S-16485 STOCKHOLM,
Tel. +46 8 632 2000, Fax. +46 8 632 2745

Switzerland: Allmendstrasse 140, CH-8027 ZÜRICH,
Tel. +41 1 488 2686, Fax. +41 1 481 7730

Taiwan: Philips Semiconductors, 6F, No. 96, Chien Kuo N. Rd., Sec. 1,
TAIPEI, Taiwan Tel. +886 2 2134 2865, Fax. +886 2 2134 2874

Thailand: PHILIPS ELECTRONICS (THAILAND) Ltd.,
209/2 Sanpavuth-Bangna Road Prakanong, BANGKOK 10260,
Tel. +66 2 745 4090, Fax. +66 2 398 0793

Turkey: Talatpasa Cad. No. 5, 80640 GÜLTEPE/ISTANBUL,
Tel. +90 212 279 2770, Fax. +90 212 282 6707

Ukraine: PHILIPS UKRAINE, 4 Patrice Lumumba str., Building B, Floor 7,
252042 KIEV, Tel. +380 44 264 2776, Fax. +380 44 268 0461

United Kingdom: Philips Semiconductors Ltd., 276 Bath Road, Hayes,
MIDDLESEX UB3 5BX, Tel. +44 181 730 5000, Fax. +44 181 754 8421

United States: 811 East Arques Avenue, SUNNYVALE, CA 94088-3409,
Tel. +1 800 234 7381

Uruguay: see South America

Vietnam: see Singapore

Yugoslavia: PHILIPS, Trg N. Pasica 5/v, 11000 BEOGRAD,
Tel. +381 11 625 344, Fax. +381 11 635 777

For all other countries apply to: Philips Semiconductors,
International Marketing & Sales Communications, Building BE-p,
P.O. Box 218, 5600 MD EINDHOVEN, The Netherlands, Fax. +31 40 27 24825

Internet: <http://www.semiconductors.philips.com>

© Philips Electronics N.V. 1997

SCA56

All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.

The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent- or other industrial or intellectual property rights.

Printed in The Netherlands

127127/00/03/pp16

Date of release: 1997 Dec 04

Document order number: 9397 750 03146

Let's make things better.

Philips
Semiconductors



PHILIPS